

N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- ☑ Advanced trench cell design
- ☑ Low Thermal Resistance

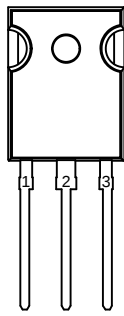
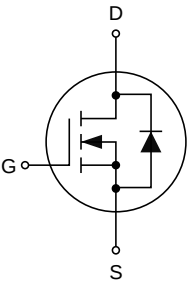
1.2 Applications

- ☑ Motor drivers
- ☑ DC/DC Converter

1.3 Quick reference

- ☑ $BV \geq 200\text{ V}$
- ☑ $P_{tot} \leq 375\text{ W}$
- ☑ $I_D \leq 165\text{ A}$
- ☑ $R_{DS(ON)} \leq 4.6\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- ☑ $R_{DS(ON)} \leq 5.0\text{ m}\Omega @ V_{GS} = 6\text{ V}$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1	Gate(G)	 Top View TO-247	
2	Drain(D)		
3	Source(S)		

3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C=25^{\circ}\text{C}$	-	200	V
V_{GS}	Gate-Source Voltage	$T_C=25^{\circ}\text{C}$	-	± 20	V
I_D^*	Drain Current (DC)	$T_C=25^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	165	A
		$T_C=100^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	118	A
$I_{DM}^{*,**}$	Drain Current (Pulsed)	$T_C=25^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	660	A
P_{tot}^*	Total Power Dissipation	$T_C=25^{\circ}\text{C}$	-	375	W
T_{stg}	Storage Temperature		-55	175	$^{\circ}\text{C}$
T_J	Junction Temperature		-	175	$^{\circ}\text{C}$
I_S	Diode Forward Current	$T_C=25^{\circ}\text{C}$	-	165	A
E_{AS}^*	Single Pulsed Avalanche Energy	$V_{DD}=50\text{ V}, L=1.0\text{ mH}$	-	3612	mJ
$R_{\theta JA}^*$	Thermal Resistance-Junction to Ambient		-	36	$^{\circ}\text{C/W}$
$R_{\theta JC}^*$	Thermal Resistance-Junction to Case		-	0.4	$^{\circ}\text{C/W}$

Notes:

- * Surface Mounted on 1 in² pad area, $t \leq 10\text{ sec}$
- ** Pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- *** Limited by bonding wire

4. Marking Information

Product Name	Marking
KJ200P222	KJ200P222 AYWW01 XXXXXX AYWW01: Date Code

5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
KJ200P222	TO-247	-	-	-	

Note: KUAJIEXIN defines “Green” as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC/JEDEC J-STD-020C)

6. Electrical Characteristics (T_A=25°C Unless Otherwise Noted)

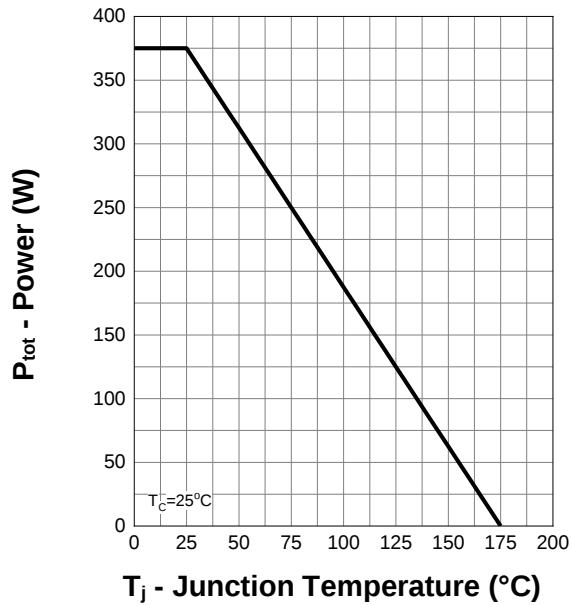
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0 V, I _{DS} =250 μA	200	-	-	V
△BV _{DSS} /△T _J	Breakdown Voltage Temp. Coefficient	Reference to 25°C, I _{DS} =5 mA	-	0.133	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250 μA	2.0	-	4.0	V/°C
I _{DSS}	Drain Leakage Current	V _{DS} =160 V, V _{GS} =0 V	-	-	1	μA
I _{GSS}	Gate Leakage Current	V _{DS} =0 V, V _{GS} =±20 V	-	-	±100	nA
R _{DS(ON)} ^a	On-State Resistance	V _{GS} =10 V, I _{DS} =30 A	-	4.0	4.6	mΩ
		V _{GS} =6 V, I _{DS} =20 A	-	4.2	5.0	
Diode Characteristics						
V _{SD} ^a	Diode Forward Voltage	I _{SD} =30 A, V _{GS} =0 V	-	-	1.3	V
t _{rr}	Reverse Recovery Time	I _{SD} =30 A, V _{GS} =0 V dI _{SD} /dt=100 A/μs	-	181	-	ns
Q _{rr}	Reverse Recovery Charge		-	1215	-	nC
Dynamic Characteristics ^b						
C _{iss}	Input Capacitance	V _{GS} =0 V, V _{DS} =100 V, Frequency=1 MHz	-	21600	-	pF
C _{oss}	Output Capacitance		-	970	-	
C _{rss}	Reverse Transfer Capacitance		-	90	-	
t _{d(on)}	Turn-on Delay Time	V _{DS} =100 V, V _{GEN} =10 V, R _G =3.9 Ω, R _L =3.3 Ω, I _{DS} =30 A	-	40	-	ns
t _r	Turn-on Rise Time		-	113	-	
t _{d(off)}	Turn-off Delay Time		-	135	-	
t _f	Turn-off Fall Time		-	118	-	
Gate Charge Characteristics ^b						
Q _g	Total Gate Charge	V _{DS} =100 V, V _{GS} =10 V, I _{DS} =30 A	-	314	-	nC
Q _{gs}	Gate-Source Charge		-	107	-	
Q _{gd}	Gate-Drain Charge		-	38	-	

Notes:

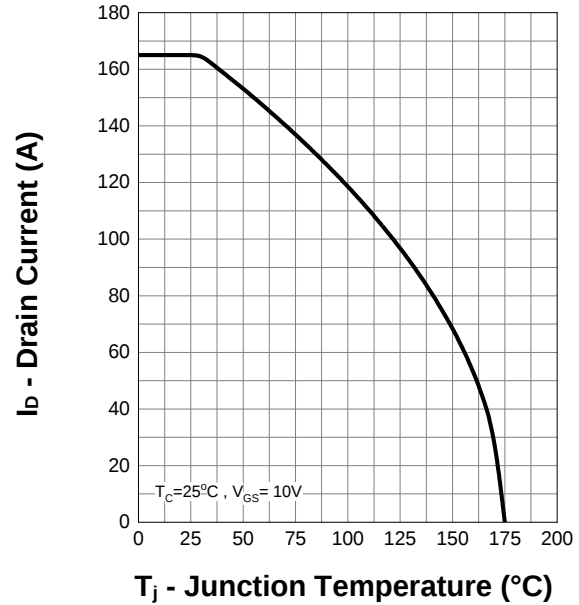
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%
- Guaranteed by design, not subject to production testing

7. Typical Characteristics

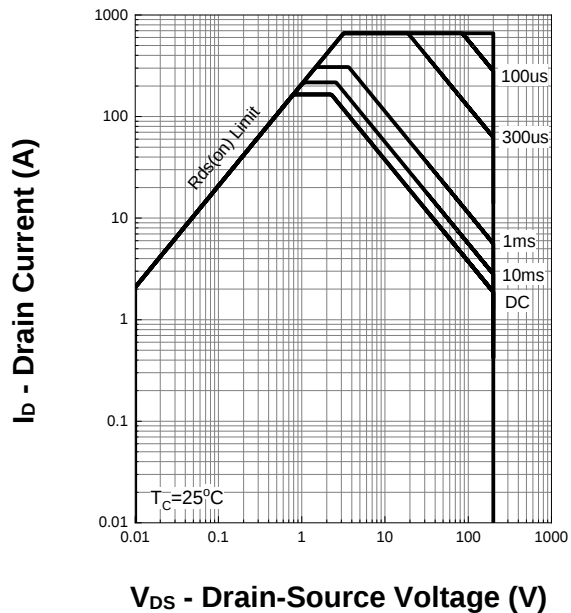
Power Capability



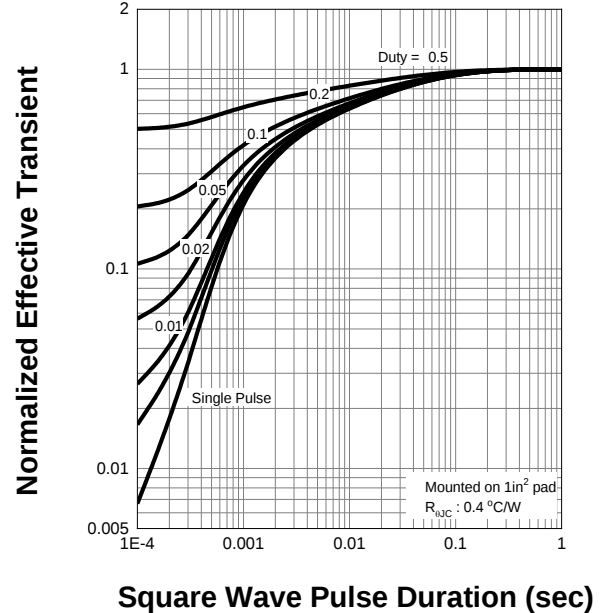
Current Capability



Safe Operating Area

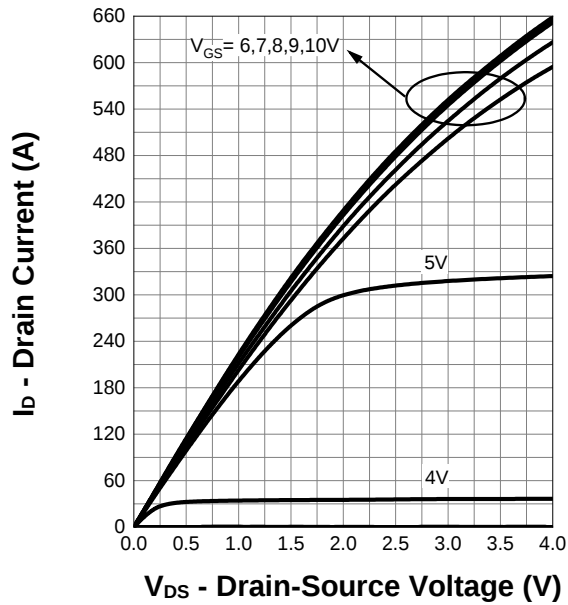


Transient Thermal Impedance

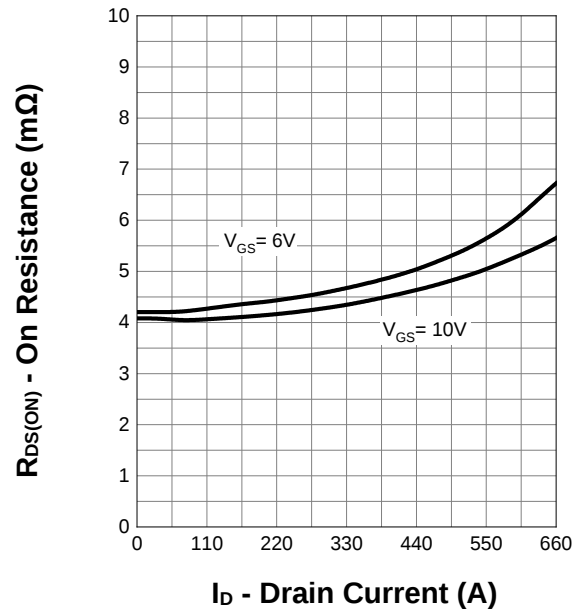


7. Typical Characteristics (cont.)

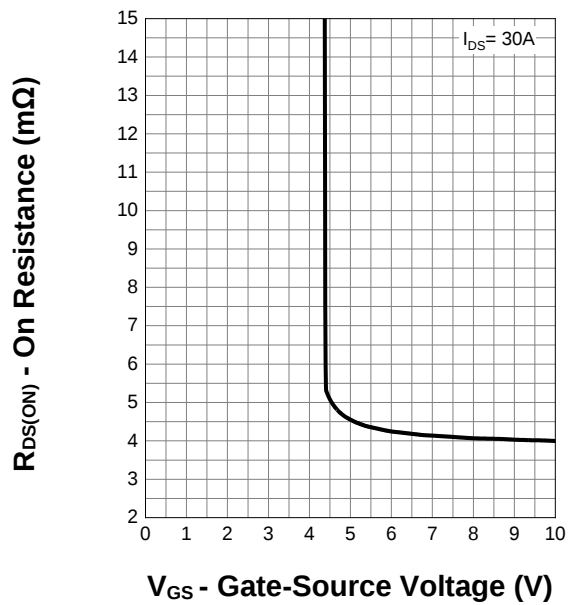
Output Characteristics



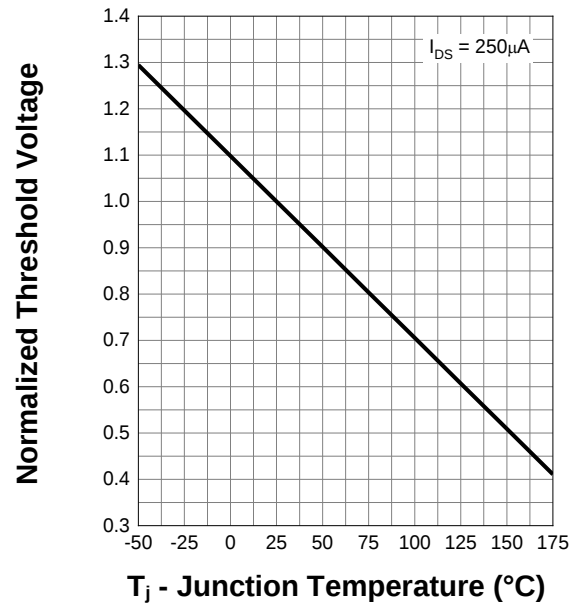
On Resistance



Transfer Characteristics

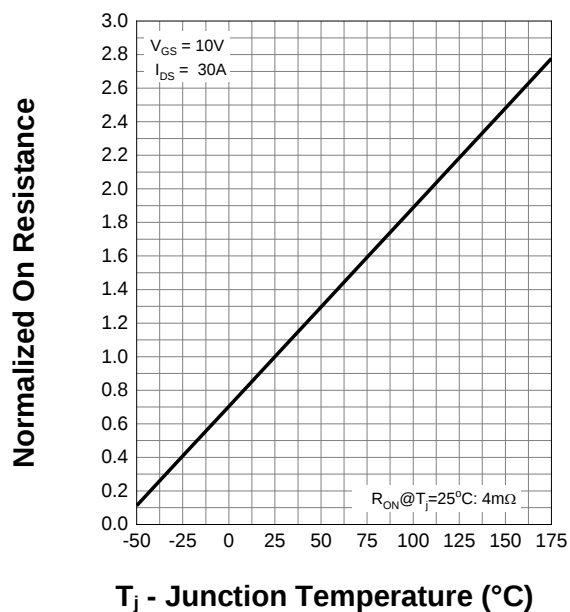


Normalized Threshold Voltage

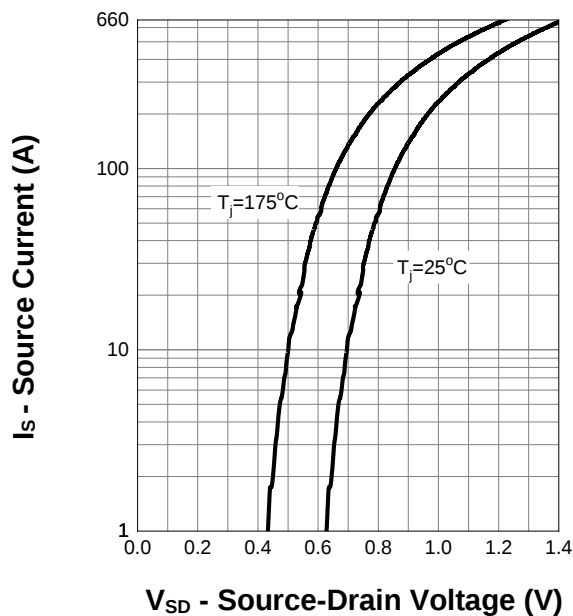


7. Typical Characteristics (cont.)

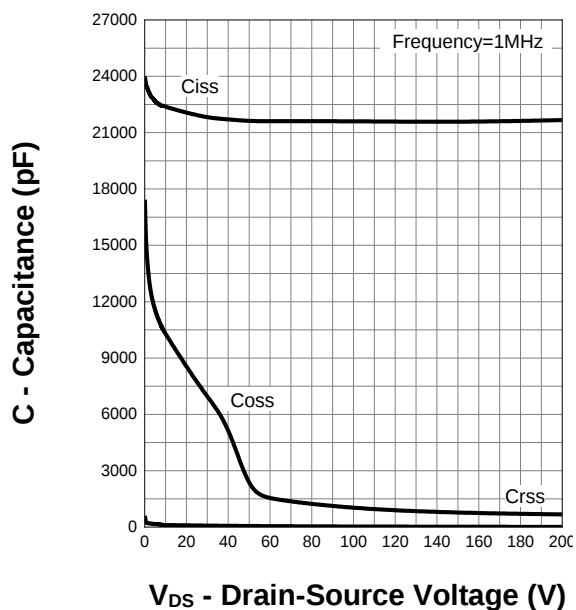
Normalized On Resistance



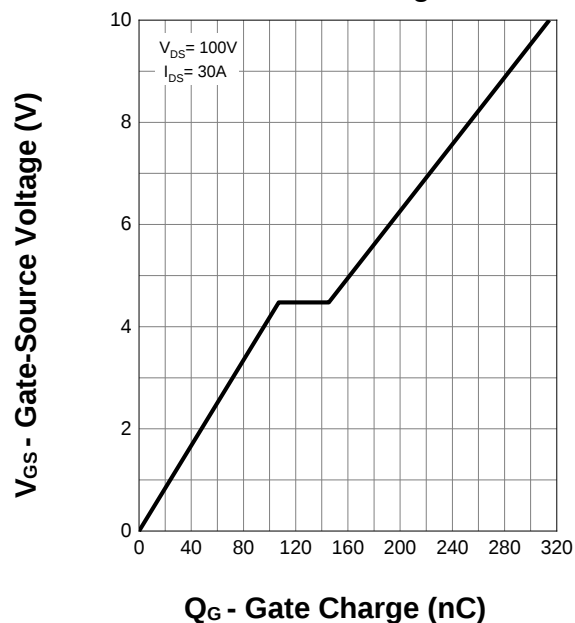
Diode Forward Current



Capacitance

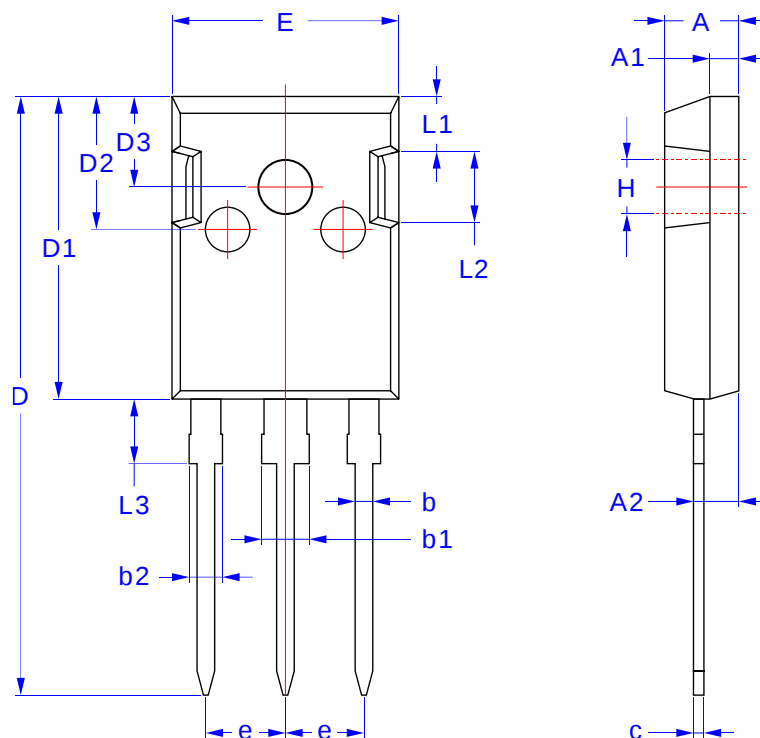


Gate Charge



8. Package Dimensions

TO-247 Package



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	MIN.	MAX.	MIN.	MAX.
A	4.90	5.10	0.1929	0.2008
A1	1.90	2.10	0.0748	0.0827
A2	2.00	3.00	0.0787	0.1181
b	0.55	0.75	0.0217	0.0295
b1	2.50	3.50	0.0984	0.1378
b2	1.75	2.50	0.0689	0.0984
c	1.20	1.30	0.0472	0.0512
D	41.00	42.00	1.6142	1.6535
D1	20.00	21.00	0.7874	0.8268
D2	8.00	10.00	0.3150	0.3937
D3	5.00	6.00	0.1969	0.2362
E	15.00	16.00	0.5906	0.6299
e	TYP 5.08		TYP 0.2000	
H	3.00	3.50	0.1181	0.1378
L1	3.50	4.00	0.1378	0.1575
L2	4.75	5.25	0.1870	0.2067
L3	4.00	5.00	0.1575	0.1969